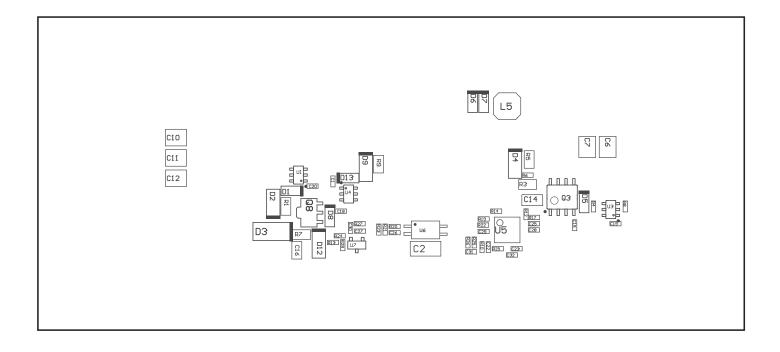


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

| PCB VIEWED FROM TOP SIDE | BOARD #: PMP9720 | REV: A | SVN REV: | : Not In VersionControl |
|----------------------------------|--------------------|---------------|----------|-------------------------|
| IGNORE -> Top Overlay | | | | |
| PLOT NAME = Top Assembly Drawing | GENERATED : 5/20/2 | 2014 12:23:50 | PM | TEXAS INSTRUMENTS |



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

| PCB VIEWED FROM BOTTOM SIDE | BOARD #: PMP9720 | REV: A | SVN REV: | Not In VersionControl |
|-------------------------------------|-------------------------|---------------|----------|-----------------------|
| | Bottom Overlay <- ANNAI | | | Bottom Ove |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 5/20/2 | 2014 12:23:51 | PM | TEXAS INSTRUMENTS |

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